

FEATURES

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- Glass Passivated Chip Junction
- High Surge Current Capability
- Fast Switching For Fast Recovery
- Meet AEC-Q101 Requirements



SOD-123FL



Schematic Symbol

APPROVALS

RoHS Compliance with 2011/65/EU

HF Compliance with IEC61249-2-21:2003

APPLICATIONS

For Use In Fast Switching Rectification Of Power Supply, Inverters,

Converters, And Freewheeling Diodes For Consumer, And

Telecommunication.

MAXIMUM RATINGS AND CHARACTERISTICS ($T_A = 25^{\circ}C$)

Parameter		Symbol	RS1000 FLQ	RS1001 FLQ	RS1002 FLQ	RS1004 FLQ	RS1006 FLQ	RS1008 FLQ	RS1010 FLQ	Unit
Marking			R1AQ	R1BQ	R1DQ	R1GQ	R1JQ	R1KQ	R1MQ	
Maximum repetitive peak reverse voltage		V _{RRM}	50	100	200	400	600	800	1000	
Maximum RMS voltage		V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage		V _{DC}	50	100	200	400	600	800	1000	
Average Rectified Output Current @60Hz sine wave, Resistance load, TL (FIG.1)		Ι _ο	1.0							
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C Forward Surge Current (Non-repetitive)		I _{FSM}	30 60						А	
@1ms, square wave, 1 cycle, Tj=25°C Maximum instantaneous forward voltage I _{FM} =1.0A		V _F	1.3						V	
Maximum DC reverse current at	T_=25°C	I _R	5						μA	
rated DC blocking voltage	T_=125°C	.K	100							
Typical junction capacitance Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C		C	11 6					рF		
Applied Reverse Voltage of 4.0 V.D.C Maximum reverse recovery time I _F =0.5A, I _R =1.0A, I _R =0.25A		t _{rr}		15	0		250	50	00	ns
 Current squared time @1ms≤t≤8.3ms Tj=25°C		l²t	3.735						A ² s	
Typical Thermal Resistance (1)		$R_{_{\theta J-A}}$	68							
		$R_{_{\theta J\text{-L}}}$	20						°C/W	
		$R_{_{\theta J\text{-}C}}$	18							
Operating junction and storage temperature range		TJ,TSTG	-55 to +150						°C	

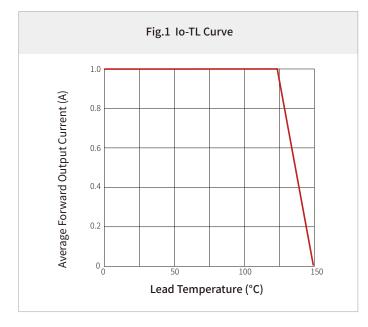
Note:

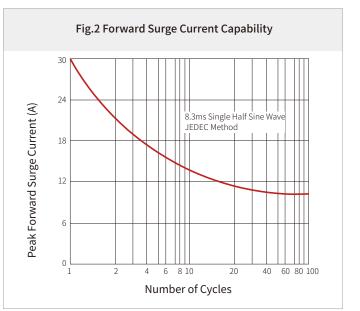
(1) Thermal resistance between junction and ambient and between junction and lead mounted on

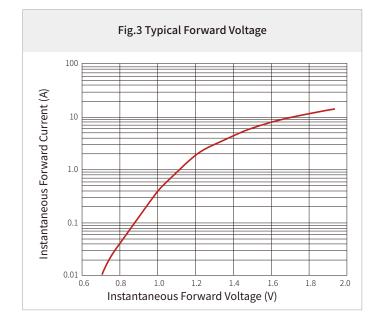
P.C.B with 3mm*3mm copper pad areas

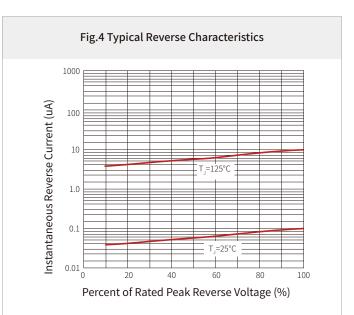


CHARACTERISTIC CURVES







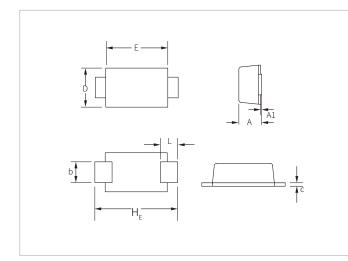




SOLDERING PARAMETERS

	Reflow Condition	Lead–free assembly
	Temperature Max (T _{s(min)})	150°C
Pre Heat	Temperature Max (T _{s(max)})	200°C
	Time (min to max) (t _s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		3°C/second max
	T _{s(max)} to T _L - Ramp-up Rate	3°C/second max
Deflaur	Temperature (T _L) (Liquidus)	217°C
Reflow	Time (min to max) (t_L)	60 – 150 seconds
Peak Temp	erature (T _P)	260°C
Time within	n 5°C of actual peak Temperature (t _p)	20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T _P)		8 minutes max.
Do not exceed		260°C

SOD-123FL PACKAGE INFORMATION



Ref.	Millim	neters	Inches			
Nel.	Min.	Мах.	Min.	Max.		
А	0.95	1.45	0.037	0.057		
A1	0.00	0.10	0.000	0.004		
b	0.70	1.20	0.028	0.047		
С	0.05	0.30	0.002	0.012		
D	1.50	2.00	0.059	0.079		
E	2.50	2.90	0.098	0.114		
L	0.35	0.90	0.014	0.035		
Η _E	3.40	3.90	0.134	0.154		



RECOMMENDED PAD LAYOUT DIMENSIONS

→ A	Ref.	Millimeters	Inches
	А	4.20	0.165
− −B− →	В	1.50	0.059
	С	1.20	0.047

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
RS1000FLQ-RS1010FLQ	SOD-123FL	3000PCS	7"



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By QR Code





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